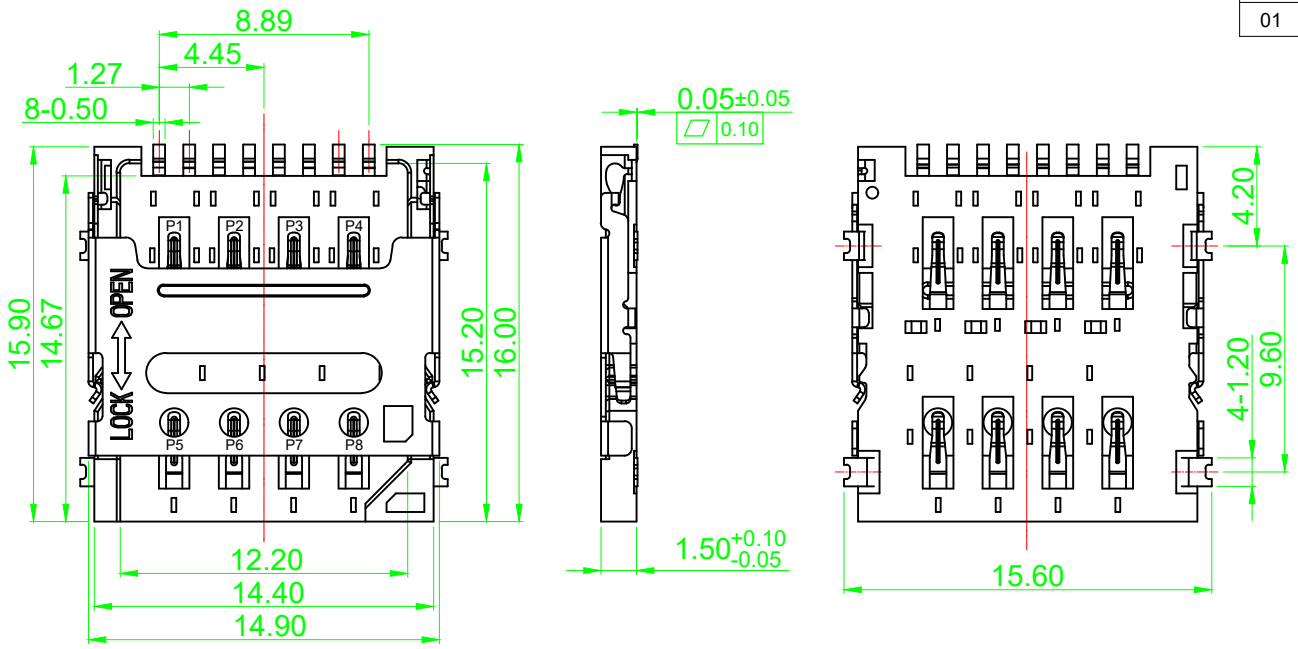
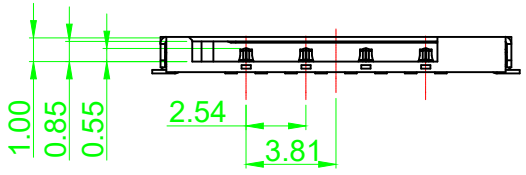
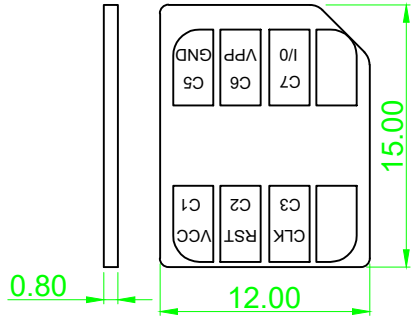
Rev.	Description.	Date	App.
01			



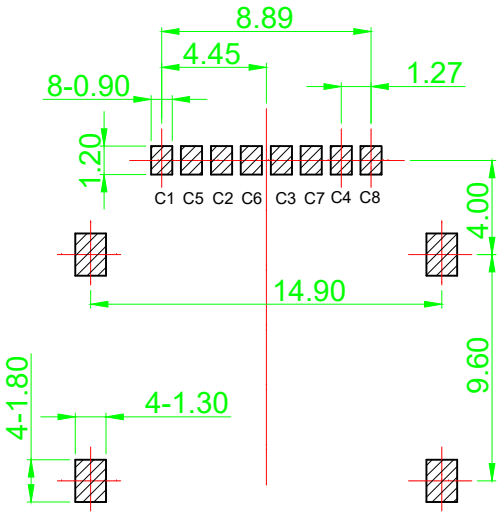
NOTES:
1.MATERIAL:
HOUSING: LCP, UL94V-0, BLACK
CONTACT: COPPER ALLOY
SHELL: SUS304
2.FINISH:
CONTACT:
CONTACT AREA: G/F GOLD PLATED
SOLDER AREA: G/F GOLD PLATED
UNDER PLATING: NICKEL PLATED
SHELL:
SOLDER AREA: G/F GOLD PLATED
UNDER PLATING: NICKEL PLATED.
3.SPECIFICATION:
CURRENT RATING: 1A Max.
VOLTAGE RATING: 30V AC/DC
DIELECTRIC WITHSTANDING: 500V AC FOR 1 MINUTE
CONTACT RESISTANCE: 30mΩ MAX.
INSULATION RESISTANCE: 1000MΩ MIN.
OPERATING TEMPERATURE: -30°C to +85°C
DURABILITY: 5000 CYCLES MIN.



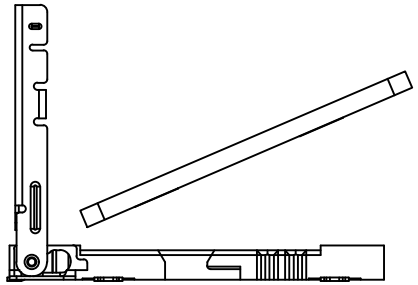


MICRO SIM CARD

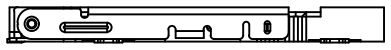
PIN NO.	NAME
C1	VCC
C2	RST
C3	CLK
C4	RESERVED
C5	GND
C6	VPP
C7	I/O
C8	RESERVED



RECOMMENDED PCB LAYOUT
TOLERANCE:±0.05



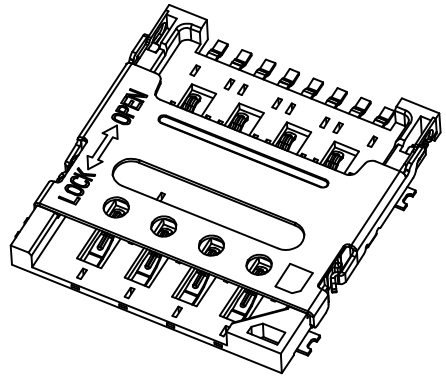
STEP 1 INSERT Micro-SIM CARD



STEP 2 PUSH THE SHELL



STEP 3 FINISH



研騰國際企業股份有限公司 YANNIS ELECTRONICS CO.,LTD.	PROJECTION:	UNIT: mm	GENERAL TOLERANCES: .X ±0.30 X°. ±3° .XX ±0.20 .X° ±1° .XXX ±0.10	APPROVED	David	SHEET: 1 OF 1	REV.: A	NAME	Micro SIM Hinge Type 8 Pin H:1.5mm
		SCALE: Free		CHECKED	Sunny				
				DRAWN	Juno	DATE: 2021/01/26		PART NO.	MSIM-01C09080 DWG NO. MSIM-01C09080_01